

100V N-Channel DTMOS

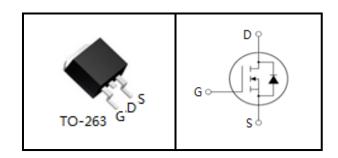
FEATURES

- Trench Power DTMOS technology
- Low R_{DS(ON)}
- Low Gate Charge
- Optimized for fast-switching applications

APPLICATIONS

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial

Device Marking and Package Information				
Device	Package	Marking		
TSB15N10A	TO-263	15N10A		





Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted				
Parameter	Symbol	Value	Unit	
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	100	V	
Continuous Drain Current (Package Limited)	I _D	150	Α	
Pulsed Drain Current (note1)	I _{DM}	600	Α	
Gate-Source Voltage	V _{GSS}	±20	V	
Single Pulse Avalanche Energy (note2)	E _{AS}	609	mJ	
Avalanche Current (note1)	I _{AS}	28	Α	
Power Dissipation (T _C = 25°C)	P _D	208	W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150	°C	

Thermal Resistance				
Parameter	Symbol	Value	Unit	
Thermal Resistance, Junction-to-Case	R _{thJC}	0.6	000	
Thermal Resistance, Junction-to-Ambient	R _{thJA}	60	°C/W	



Specifications $T_J = 25^{\circ}$ C, unless otherwise noted						
Doromotor	ameter Symbol Test Conditions		Value			
Parameter		Min.	Тур.	Max.	Unit	
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	100			V
Zana Oata Vallana Busin Our	I _{DSS}	$V_{DS} = 100V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μΑ
Zero Gate Voltage Drain Current		$V_{DS} = 100V, V_{GS} = 0V, T_{J} = 150^{\circ}C$			100	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20V$			±100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 50A		3.5	4.2	mΩ
Forward Transconductance (Note3)	g _{fs}	$V_{DS} = 10V, I_{D} = 50A$		140		S
Dynamic						
Input Capacitance	C _{iss}	$V_{GS} = 0V$,		7700		pF
Output Capacitance	C _{oss}	$V_{DS} = 50V$,		470		
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		28		
Total Gate Charge	Q_g	$V_{DD} = 50V, I_{D} = 50A,$ $V_{GS} = 10V$		138		nC
Gate-Source Charge	Q_{gs}			37		
Gate-Drain Charge	Q_{gd}	. 65		35.5		
Turn-on Delay Time	t _{d(on)}			35		
Turn-on Rise Time	t _r	$V_{DD} = 50V, I_D = 50A,$ $R_G = 25\Omega$		22		ns
Turn-off Delay Time	t _{d(off)}			105		
Turn-off Fall Time	t _f			45		
Drain-Source Body Diode Characteri	stics					
Continuous Body Diode Current	Is	T _C = 25°C			50	Λ
Pulsed Diode Forward Current	I _{SM}				150	А
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 50\text{A}, V_{GS} = 0\text{V}$		0.9	1.2	V
Reverse Recovery Time	t _{rr}	I _F = 50A,		50		ns
Reverse Recovery Charge	Q _{rr}	di _F /dt = 500A/μs		110		nC

Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 28A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 1%



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

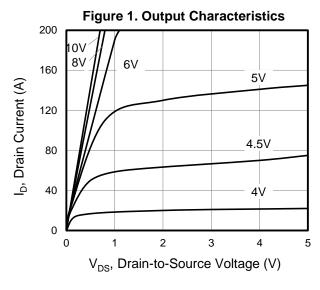


Figure 3. On-Resistance vs. Drain Current

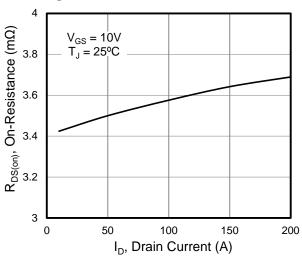


Figure 5. Gate Charge

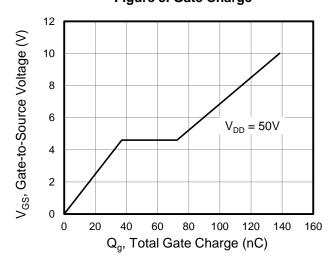


Figure 2. Transfer Characteristics

V_{DS} = 10V

T_J = 25°C

100

80

60

40

20

0

I_D, Drain Current (A)

V_{GS}, Gate-to-Source Voltage (V)

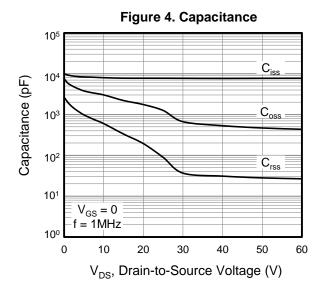
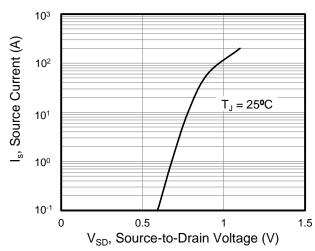


Figure 6. Body Diode Forward Voltage





Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

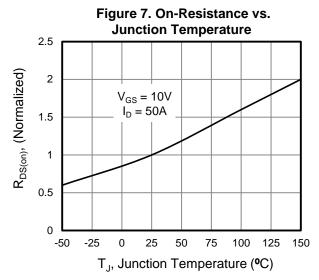
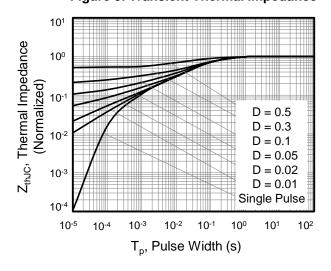


Figure 9. Transient Thermal Impedance



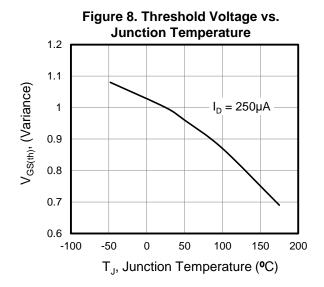




Figure A: Gate Charge Test Circuit and Waveform

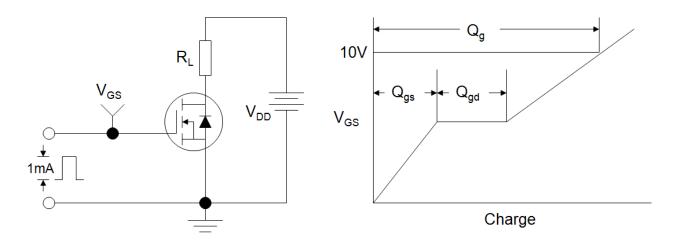


Figure B: Resistive Switching Test Circuit and Waveform

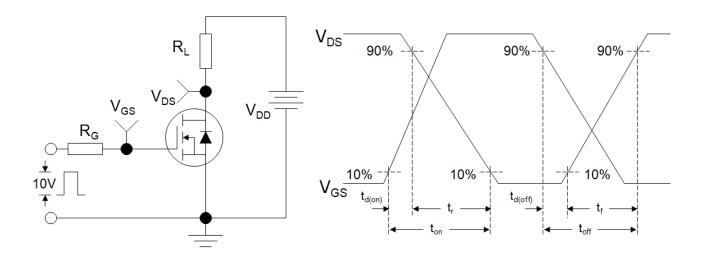
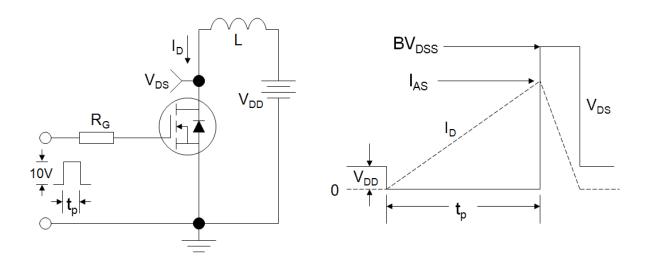
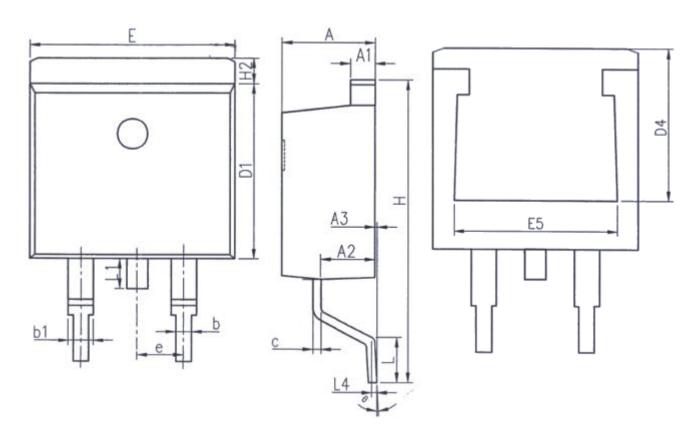


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





TO-263



Unit: mm				
Symbol	Min.	Max.		
Α	4. 37	4. 77		
A 1	1. 22	1. 42		
A2	2. 49	2. 89		
A3	0.00	0. 25		
b	0. 70	0. 96		
b1	1. 17	1. 47		
С	0. 30	0. 53		
D1	8. 50	8. 90		
D4	6. 60	_		

Unit: mm				
Symbol	Min.	Max.		
E	9.86	10.36		
E 5	7. 06	-		
е	2. 54BSC			
Н	14. 70	15. 50		
H2	1. 07	1. 47		
L	2. 00	2. 60		
L1	1. 40 1. 70			
L4	0. 25BSC			
θ	0°	9°		



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